

AMENDMENTS (ARTICLE 34)

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1) A portion from line 25 on page 2 to line 11 on page 3 and lines 24-30 on
5 page 3 in the specification are deleted in accordance with amended claims.

2) "(5)" at line 12 on page 3 is changed to --(1)--, and "(7)" at line 31 on
page 3 is changed to --(2)--.

3) Between line 19 and line 20 on page 5 the following sentence is inserted.

10 "Here two types of lower dies are employed, one is the lower die 202
having the substrate region in which substrate is placed and the other (not
shown) is a die having no substrate regions, but other dimensions are
preferably the same as the lower die 202."

4) Portion "and the unvulcanized rubber material 102 is set in the pot
region204" at lines 23-24 on page 5 are deleted.

15 5) A portion from line 25 on page 5 to line 6 on page 6 is replaced with the
following sentences.

"Then unvulcanized rubber parts are molded in a die assembly
constituted by combining the other lower die having no substrate regions and
the upper die 201.

20 At this step, the other die having no substrate regions 206 is precisely
fitted to the upper die 201 and then the piston 205 is pressed by the press so
that the rubber material 102 is pressed.

25 Since the other lower die has no substrate regions 206, only
unvulcanized rubber parts having a desired shape are molded, when the
rubber material 201 is fed to and fills the cavities 207 of the upper die 201
via the gate regions 203 (a molding step).

In the present embodiment, since the placing step and the molding step
do not necessarily carry out in the explained order, combined steps are
renamed as a placing-molding step.

30 Then the other lower die is replaced with the lower die 202 having the
substrate region in which the substrate 101 is placed by sliding or the like.

The lower die 202 having the substrate region is fitted precisely to the upper die 201 so that the molded rubber material in the cavities 207 are arranged at desired position (an arranging step).

The substrate on which the unvulcanized rubber parts are placed, is taken out of the die assembly (a die releasing step) and vulcanized without heating (a vulcanizing step), thus the rubber parts monolithically combined with the substrate are obtained."

6) Lines 13-15 on page 6 are deleted.

7) Portion of "(will be explained hereinafter)" at lines 27-28 on page 6 is deleted.

8) Lines 30-31 on page 6 are deleted.

9) Lines 15-26 on page 7 are deleted.

10) Portion "so that the anchor.....can be omitted" from line 30 on page 7 to line 1 on page 8 is deleted.

11) A portion from line 30 on page 8 to line 10 on page 9 is deleted.

12) A portion from line 14 on page 9 to line 22 on page 10 is deleted.

13) Portion "in addition to the effects by embodiment 1, embodiment 2" at line 23 on page 10 is changed to --in addition to the ordinary substrate the present embodiment--.

14) Portion "In either embodiment," at line 27 on page 10 is deleted.

15) Lines 26-28 on page 11 are deleted.

16) Claims 1-4 are deleted.

17) FIG.1 is amended.